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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant Yuanning Chen, et al.

Docket Number: TI-35022.2

Serial No.: 10/719,279

Art Unit: 2813

Filed: 11/21/03

Examiner: Jack S.J. Chen

For: Use of Hafnium Silicon Oxynitride as the Cap Layer of the
Sidewall Spacer

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NAME OF INVENTOR(S): Yuanning Chen, et al.	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/719,279 Filing Date: 11/21/03	
TITLE OF INVENTION: Use of Hafnium Silicon Oxynitride as the Cap Layer of the Sidewall Spacer	
TI FILE NO.: TI-35022.2	DEPOSIT ACCT. NO.: 20-0668
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